Silicon N Channel MOS FET High Speed Power Switching

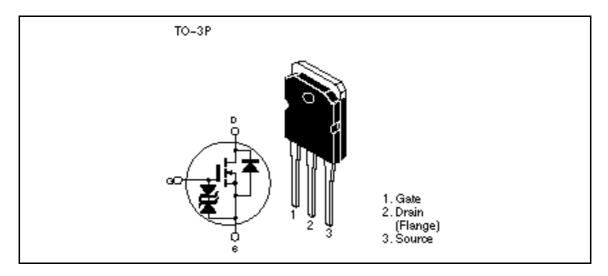


ADE-208-455 A 2nd. Edition

Features

- Low on-resistance
- High speed switching
- Low drive current
- Avalanche ratings

Outline





Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	500	V	
Gate to source voltage	V _{GSS}	±30	V	
Drain current	I _D	20	А	
Drain peak current	L _{D(pulse)} *1	80	А	
Body to drain diode reverse drain current	I _{DR}	20	А	
Avalanche current	l* ³	20	А	
Avalanche energy	E _{AR} * ³	22	mJ	
Channel dissipation	Pch* ²	150	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	
Noton 1 DW 10 up duty avala 1 %				

Notes: 1. PW 10 μ s, duty cycle 1 %

2. Value at $Tc = 25^{\circ}C$

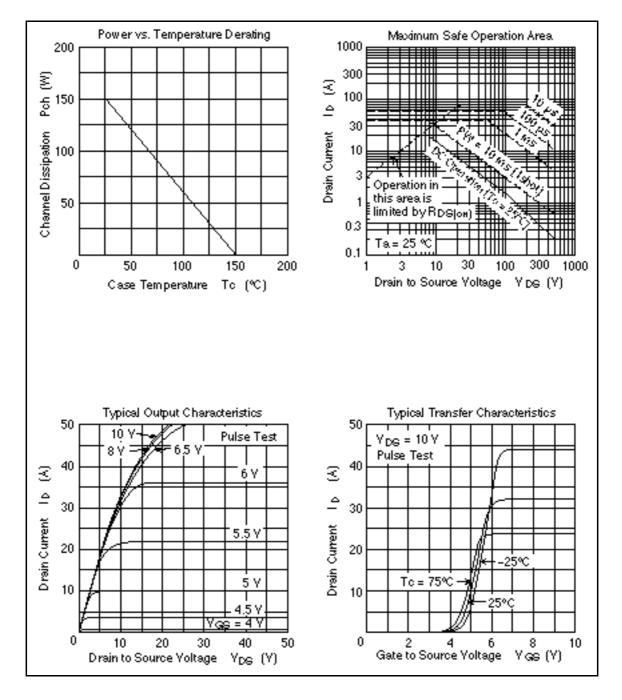
3. Value at Tch = 25°C, Rg $\,$ 50 $\,$, L = 100 μH

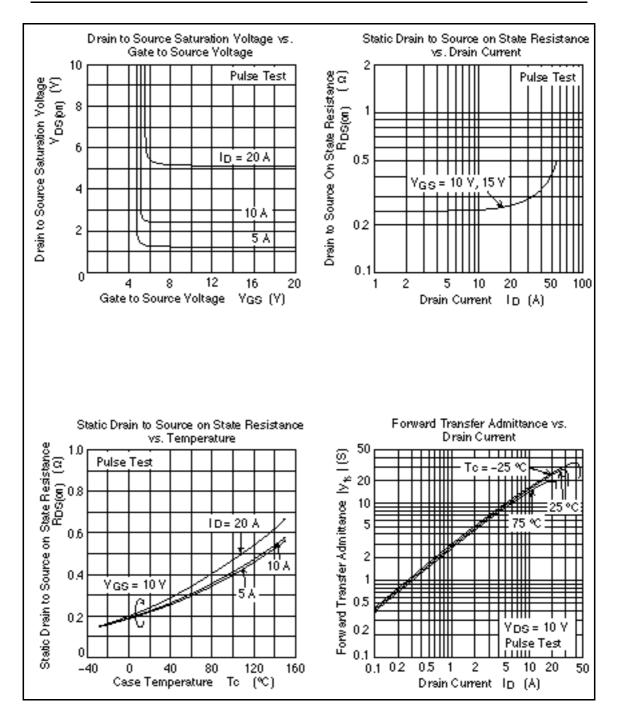
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	500	_	_	V	$I_{\rm D} = 10 {\rm mA}, V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(\text{BR})\text{GSS}}$	±30	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 25V, V_{DS} = 0$
Zero gate voltege drain current	I _{DSS}	_	—	10	μΑ	$V_{DS} = 500 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.5	_	3.5	V	$I_{\rm D} = 1$ mA, $V_{\rm DS} = 10$ V ^{*1}
Static drain to source on state resistance	$R_{\text{DS(on)}}$	_	0.24	0.29		$I_{\rm D} = 10$ A, $V_{\rm GS} = 10$ V ^{*1}
Forward transfer admittance	y _{fs}	9	15		S	$I_{\rm D} = 10$ A, $V_{\rm DS} = 10$ V ^{*1}
Input capacitance	Ciss	_	3300	_	pF	$V_{DS} = 10V$
Output capacitance	Coss	_	900	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	120	_	pF	f = 1MHz
Total gate charge	Qg	_	55	_	nc	$V_{DD} = 400 V$
Gate to source charge	Qgs	_	14	_	nc	$V_{GS} = 10V$
Gate to drain charge	Qgd	_	17	_	nc	$I_{D} = 20A$
Turn-on delay time	t _{d(on)}	_	45	_	ns	$V_{GS} = 10V, I_{D} = 10A$
Rise time	t,	_	140	_	ns	$R_{L} = 3$
Turn-off delay time	$t_{d(off)}$		150		ns	_
Fall time	t _f	—	85		ns	
Body to drain diode forward voltage	V_{DF}	—	1.0	—	V	$I_{\rm D} = 20$ A, $V_{\rm GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	—	400	—	ns	$I_{F} = 20A, V_{GS} = 0$ diF/ dt = 100A/µs
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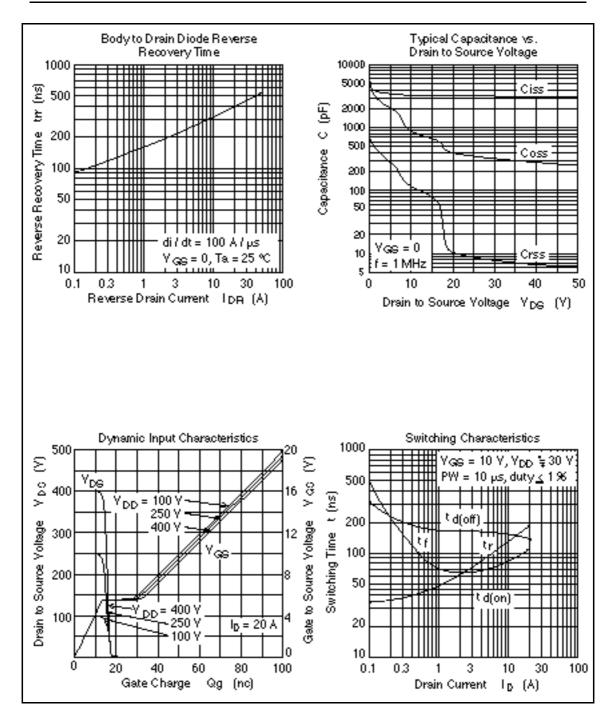
Electrical Characteristics (Ta = 25° C)

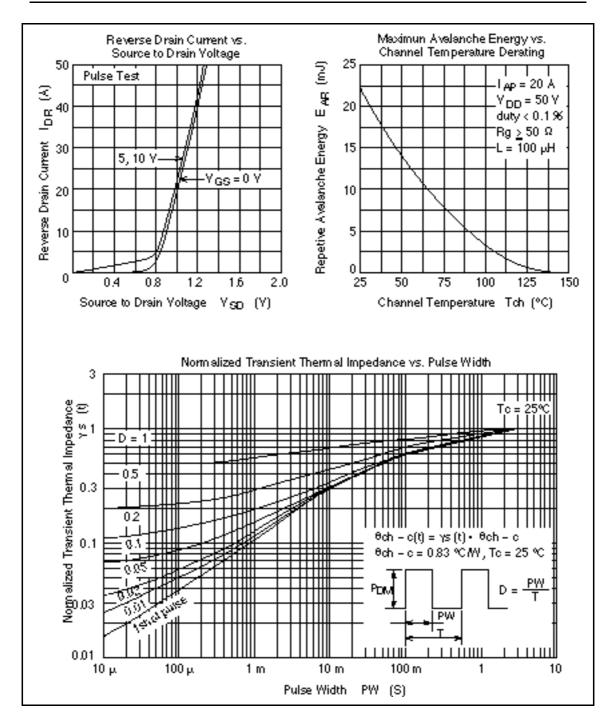
Note: 1. Pulse test

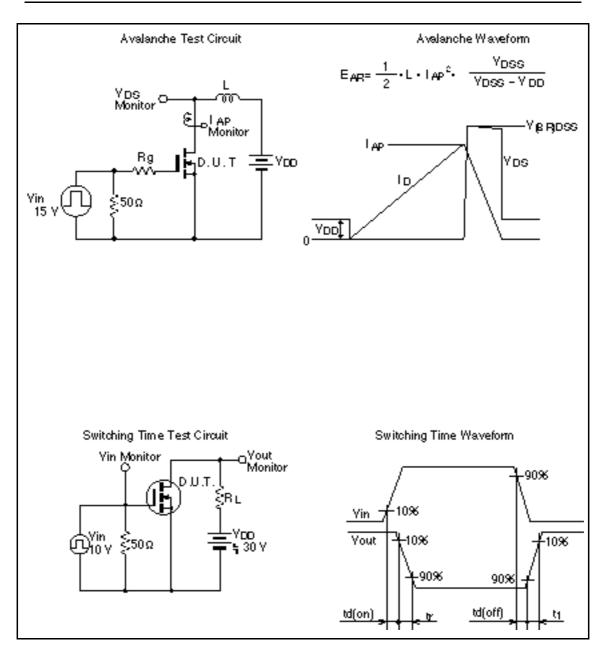
Main Characteristics



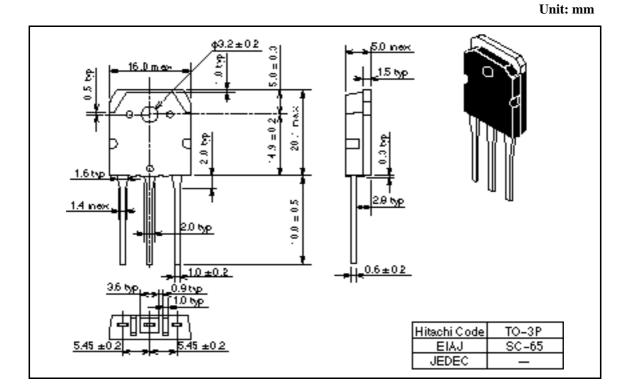








Package Dimentions



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